

## Introduction

The MAX<sup>®</sup> II family of instant-on, non-volatile CPLDs is based on a 0.18- $\mu$ m, 6-layer-metal-flash process, with densities from 240 to 2,210 logic elements (LEs) (128 to 2,210 equivalent macrocells) and non-volatile storage of 8 Kbits. MAX II devices offer high I/O counts, fast performance, and reliable fitting versus other CPLD architectures. Featuring MultiVolt core, a user flash memory (UFM) block, and enhanced in-system programmability (ISP), MAX II devices are designed to reduce cost and power while providing programmable solutions for applications such as bus bridging, I/O expansion, power-on reset (POR) and sequencing control, and device configuration control.

## Features

The MAX II CPLD has the following features:

- Low-cost, low-power CPLD
- Instant-on, non-volatile architecture
- Standby current as low as 25  $\mu$ A
- Provides fast propagation delay and clock-to-output times
- Provides four global clocks with two clocks available per logic array block (LAB)
- UFM block up to 8 Kbits for non-volatile storage
- MultiVolt core enabling external supply voltages to the device of either 3.3 V/2.5 V or 1.8 V
- MultiVolt I/O interface supporting 3.3-V, 2.5-V, 1.8-V, and 1.5-V logic levels
- Bus-friendly architecture including programmable slew rate, drive strength, bus-hold, and programmable pull-up resistors
- Schmitt triggers enabling noise tolerant inputs (programmable per pin)
- I/Os are fully compliant with the Peripheral Component Interconnect Special Interest Group (PCI SIG) PCI Local Bus Specification, Revision 2.2 for 3.3-V operation at 66 MHz
- Supports hot-socketing
- Built-in Joint Test Action Group (JTAG) boundary-scan test (BST) circuitry compliant with IEEE Std. 1149.1-1990
- ISP circuitry compliant with IEEE Std. 1532


Table 1-1 shows the MAX II family features.

**Table 1-1.** MAX II Family Features

Feature	EPM240 EPM240G	EPM570 EPM570G	EPM1270 EPM1270G	EPM2210 EPM2210G	EPM240Z	EPM570Z
LEs	240	570	1,270	2,210	240	570
Typical Equivalent Macrocells	192	440	980	1,700	192	440
Equivalent Macrocell Range	128 to 240	240 to 570	570 to 1,270	1,270 to 2,210	128 to 240	240 to 570
UFM Size (bits)	8,192	8,192	8,192	8,192	8,192	8,192
Maximum User I/O pins	80	160	212	272	80	160
$t_{PD1}$ (ns) (1)	4.7	5.4	6.2	7.0	7.5	9.0
$f_{CNT}$ (MHz) (2)	304	304	304	304	152	152
$t_{SU}$ (ns)	1.7	1.2	1.2	1.2	2.3	2.2
$t_{CO}$ (ns)	4.3	4.5	4.6	4.6	6.5	6.7

**Notes to Table 1-1:**

- (1)  $t_{PD1}$  represents a pin-to-pin delay for the worst case I/O placement with a full diagonal path across the device and combinational logic implemented in a single LUT and LAB that is adjacent to the output pin.
- (2) The maximum frequency is limited by the I/O standard on the clock input pin. The 16-bit counter critical delay will run faster than this number.

 For more information about equivalent macrocells, refer to the *MAX II Logic Element to Macrocell Conversion Methodology* white paper.

MAX II and MAX IIG devices are available in three speed grades: -3, -4, and -5, with -3 being the fastest. Similarly, MAX IIZ devices are available in three speed grades: -6, -7, and -8, with -6 being the fastest. These speed grades represent the overall relative performance, not any specific timing parameter. For propagation delay timing numbers within each speed grade and density, refer to the *DC and Switching Characteristics* chapter in the *MAX II Device Handbook*.

Table 1-2 shows MAX II device speed-grade offerings.

**Table 1-2.** MAX II Speed Grades

Device	Speed Grade					
	-3	-4	-5	-6	-7	-8
EPM240 EPM240G	✓	✓	✓	—	—	—
EPM570 EPM570G	✓	✓	✓	—	—	—
EPM1270 EPM1270G	✓	✓	✓	—	—	—
EPM2210 EPM2210G	✓	✓	✓	—	—	—
EPM240Z	—	—	—	✓	✓	✓
EPM570Z	—	—	—	✓	✓	✓

MAX II devices are available in space-saving FineLine BGA, Micro FineLine BGA, and thin quad flat pack (TQFP) packages (refer to [Table 1-3](#) and [Table 1-4](#)). MAX II devices support vertical migration within the same package (for example, you can migrate between the EPM570, EPM1270, and EPM2210 devices in the 256-pin FineLine BGA package). Vertical migration means that you can migrate to devices whose dedicated pins and JTAG pins are the same and power pins are subsets or supersets for a given package across device densities. The largest density in any package has the highest number of power pins; you must lay out for the largest planned density in a package to provide the necessary power pins for migration. For I/O pin migration across densities, cross reference the available I/O pins using the device pin-outs for all planned densities of a given package type to identify which I/O pins can be migrated. The Quartus® II software can automatically cross-reference and place all pins for you when given a device migration list.

**Table 1-3.** MAX II Packages and User I/O Pins

Device	68-Pin Micro FineLine BGA (1)	100-Pin Micro FineLine BGA (1)	100-Pin FineLine BGA	100-Pin TQFP	144-Pin TQFP	144-Pin Micro FineLine BGA (1)	256-Pin Micro FineLine BGA (1)	256-Pin FineLine BGA	324-Pin FineLine BGA
EPM240 EPM240G	—	80	80	80	—	—	—	—	—
EPM570 EPM570G	—	76	76	76	116	—	160	160	—
EPM1270 EPM1270G	—	—	—	—	116	—	212	212	—
EPM2210 EPM2210G	—	—	—	—	—	—	—	204	272
EPM240Z	54	80	—	—	—	—	—	—	—
EPM570Z	—	76	—	—	—	116	160	—	—

**Note to Table 1-3:**

(1) Packages available in lead-free versions only.

**Table 1-4.** MAX II TQFP, FineLine BGA, and Micro FineLine BGA Package Sizes

Package	68-Pin Micro FineLine BGA	100-Pin Micro FineLine BGA	100-Pin FineLine BGA	100-Pin TQFP	144-Pin TQFP	144-Pin Micro FineLine BGA	256-Pin Micro FineLine BGA	256-Pin FineLine BGA	324-Pin FineLine BGA
Pitch (mm)	0.5	0.5	1	0.5	0.5	0.5	0.5	1	1
Area (mm <sup>2</sup> )	25	36	121	256	484	49	121	289	361
Length × width (mm × mm)	5 × 5	6 × 6	11 × 11	16 × 16	22 × 22	7 × 7	11 × 11	17 × 17	19 × 19

MAX II devices have an internal linear voltage regulator which supports external supply voltages of 3.3 V or 2.5 V, regulating the supply down to the internal operating voltage of 1.8 V. MAX IIG and MAX IIZ devices only accept 1.8 V as the external supply voltage. MAX IIZ devices are pin-compatible with MAX IIG devices in the 100-pin Micro FineLine BGA and 256-pin Micro FineLine BGA packages. Except for external supply voltage requirements, MAX II and MAX II G devices have identical pin-outs and timing specifications. Table 1-5 shows the external supply voltages supported by the MAX II family.

**Table 1-5.** MAX II External Supply Voltages

Devices	EPM240 EPM570 EPM1270 EPM2210	EPM240G EPM570G EPM1270G EPM2210G EPM240Z EPM570Z (1)
MultiVolt core external supply voltage ( $V_{CCINT}$ ) (2)	3.3 V, 2.5 V	1.8 V
MultiVolt I/O interface voltage levels ( $V_{CCIO}$ )	1.5 V, 1.8 V, 2.5 V, 3.3 V	1.5 V, 1.8 V, 2.5 V, 3.3 V

**Notes to Table 1-5:**

- (1) MAX IIG and MAX IIZ devices only accept 1.8 V on their  $V_{CCINT}$  pins. The 1.8-V  $V_{CCINT}$  external supply powers the device core directly.
- (2) MAX II devices operate internally at 1.8 V.

## Referenced Documents

This chapter references the following documents:

- *DC and Switching Characteristics* chapter in the *MAX II Device Handbook*
- *MAX II Logic Element to Macrocell Conversion Methodology* white paper

## Document Revision History

Table 1-6 shows the revision history for this chapter.

**Table 1-6.** Document Revision History

Date and Revision	Changes Made	Summary of Changes
August 2009, version 1.9	■ Updated Table 1-2.	Added information for speed grade -8
October 2008, version 1.8	■ Updated "Introduction" section. ■ Updated new Document Format.	—
December 2007, version 1.7	■ Updated Table 1-1 through Table 1-5. ■ Added "Referenced Documents" section.	Updated document with MAX IIZ information.
December 2006, version 1.6	■ Added document revision history.	—
August 2006, version 1.5	■ Minor update to features list.	—
July 2006, version 1.4	■ Minor updates to tables.	—

**Table 1-6.** Document Revision History

<b>Date and Revision</b>	<b>Changes Made</b>	<b>Summary of Changes</b>
June 2005, version 1.3	■ Updated timing numbers in Table 1-1.	—
December 2004, version 1.2	■ Updated timing numbers in Table 1-1.	—
June 2004, version 1.1	■ Updated timing numbers in Table 1-1.	—

